SGM4553YVS
2-Bit Bidirectional Voltage-Level Translator for Open-Drain and Push-Pull Applications

GENERAL DESCRIPTION

The SGM4553YVS is a 2-bit, non-inverting, bidirectional voltage-level translator which features two independent configurable power-supply lines. The A and B ports track the V_{CCA} supply and V_{CCB} supply respectively. The supply voltage range is 1.65V to 5.5V for A ports and 2.3V to 5.5V for B ports. The device provides a bidirectional translation function among the different voltage nodes (including 1.8V, 2.5V, 3.3V and 5V).

The SGM4553YVS has an output-enabled (OE) function, which controls the inputs and outputs states. When OE goes low, all I/Os enter into the high-impedance state. It is beneficial for reducing quiescent current consumption. When V_{CCA} is powered, OE has an internal pull-down current source.

The SGM4553YVS is available in a Green VSSOP-8 package. It operates over an ambient temperature range of -40℃ to +85℃.

FEATURES

- **Power Supply Voltage Ranges ($V_{CCA} \leq V_{CCB}$)**
  - **A Ports: 1.65V to 5.5V**
  - **B Ports: 2.3V to 5.5V**
- **Direction-Control Signal is Not Required**
- **Data Rates**
  - **Push-Pull: 24Mbps**
  - **Open-Drain: 2Mbps**
- **Support V_{CCA} or V_{CCB} Isolation**
  - **When V_{CCA} or V_{CCB} is Low, Device Enters Power-Down Mode**
- **No Specific Power Sequences Required for V_{CCA} and V_{CCB}**
- **Support Power-Down Mode**
- **-40℃ to +85℃ Operating Temperature Range**
- **Available in a Green VSSOP-8 Package**

APPLICATIONS

Universal Asynchronous Receiver/Transmitter

I^2C/SMBus Interfaces

General Purpose I/O (GPIO)

TYPICAL APPLICATION

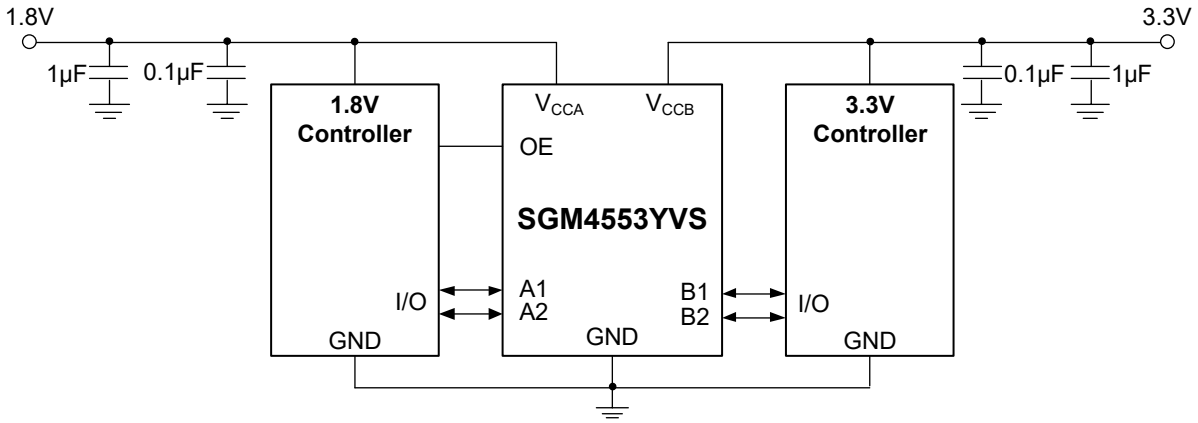


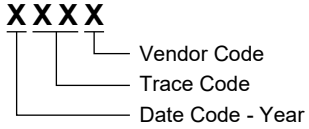
Figure 1. Typical Application Circuit

PACKAGE/ORDERING INFORMATION

MODEL	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	ORDERING NUMBER	PACKAGE MARKING	PACKING OPTION
SGM4553YVS	VSSOP-8	-40℃ to +85℃	SGM4553YVS8G/TR	4553 XXXX	Tape and Reel, 3000

MARKING INFORMATION

NOTE: XXXX = Date Code, Trace Code and Vendor Code.



Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

ABSOLUTE MAXIMUM RATINGS

Supply Voltage Range
- V_{CCA} ..... -0.3V to 6V
- V_{CCB} ..... -0.3V to 6V

Input Voltage Range, V_I (1)
A Ports, B Ports, OE ..... -0.3V to 6V

Output Voltage Range for the High-Impedance or Power-Off State, V_O (1)
- A Ports ..... -0.3V to 6V
- B Ports ..... -0.3V to 6V

Output Voltage Range for the High or Low State, V_O (1) (2)
- A Ports ..... -0.3V to V_{CCA} + 0.3V
- B Ports ..... -0.3V to V_{CCB} + 0.3V

Input Clamp Current, I_{IK} (V_I < 0) ..... -50mA
Output Clamp Current, I_{OK} (V_O < 0) ..... -50mA
Package Thermal Resistance
- VSSOP-8, θ_{JA} ..... 221.5℃/W
- VSSOP-8, θ_{JB} ..... 151.1℃/W
- VSSOP-8, θ_{JC} ..... 126.9℃/W

Junction Temperature ..... +150℃
Storage Temperature Range ..... -65℃ to +150℃
Lead Temperature (Soldering, 10s) ..... +260℃
ESD Susceptibility (3) (4)
HBM ..... ±4000V
CDM ..... ±1000V

NOTES:

1. When the input and output current ratings are observed, the input and I/O negative voltage ratings may be exceeded.

2. V_{CCA} and V_{CCB} values are shown in the recommended operating conditions in Electrical Characteristics section.

3. For human body model (HBM), all pins comply with ANSI/ESDA/JEDEC JS-001 specifications.

4. For charged device model (CDM), all pins comply with ANSI/ESDA/JEDEC JS-002 specifications.

RECOMMENDED OPERATING CONDITIONS

Operating Temperature Range ..... -40℃ to +85℃

OVERSTRESS CAUTION

Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any conditions beyond those indicated in the Recommended Operating Conditions section is not implied.

ESD SENSITIVITY CAUTION

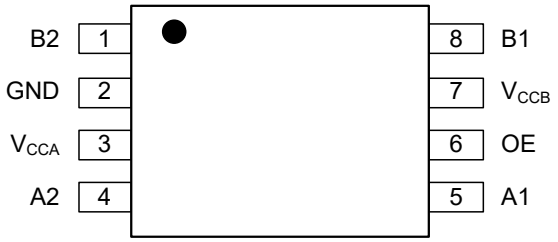
This integrated circuit can be damaged if ESD protections are not considered carefully. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because even small parametric changes could cause the device not to meet the published specifications.

DISCLAIMER

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.

PIN CONFIGURATION

(TOP VIEW)



VSSOP-8

PIN DESCRIPTION

PIN	NAME	TYPE	FUNCTION
1	B2	I/O	Channel 2 Input/Output B. It tracks the V_{CCB} supply.
2	GND	G	Ground.
3	V_{CCA}	P	Supply Voltage on A Ports. It can be operated from 1.65V to 5.5V, and V_{CCA} is always ≤ V_{CCB}.
4	A2	I/O	Channel 2 Input/Output A. It tracks the V_{CCA} supply.
5	A1	I/O	Channel 1 Input/Output A. It tracks the V_{CCA} supply.
6	OE	I	Output-Enabled Control Pin. Active high. When OE goes low, all outputs enter into the high-impedance state. It tracks the V_{CCA} supply.
7	V_{CCB}	P	Supply Voltage on B Ports. It can be operated from 2.3V to 5.5V.
8	B1	I/O	Channel 1 Input/Output B. It tracks the V_{CCB} supply.

NOTE: I = input, I/O = input/output, P = power, G = ground.

ELECTRICAL CHARACTERISTICS

(V_{CCA} = 1.65V to 5.5V, V_{CCB} = 2.3V to 5.5V, T_A = -40℃ to +85℃, typical values are measured at T_A = +25℃, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS			MIN	TYP	MAX	UNITS
Recommended Operating Conditions (1) (2)								
Supply Voltage (3)	V_{CCA}	A ports			1.65		5.5	V
	V_{CCB}	B ports			2.3		5.5	
High-Level Input Voltage	V_{IH}	A ports	V_{CCA} = 1.65V to 1.95V, V_{CCB} = 2.3V to 5.5V		V_{CCI} - 0.2		V_{CCI}	V
			V_{CCA} = 2.3V to 5.5V, V_{CCB} = 2.3V to 5.5V		V_{CCI} - 0.4		V_{CCI}	
		B ports			V_{CCI} - 0.4		V_{CCI}	
		OE			V_{CCA} × 0.8		5.5	
Low-Level Input Voltage	V_{IL}	A ports			0		0.15	V
		B ports			0		0.15	
		OE			0		V_{CCA} × 0.25	
Electrical Characteristics								
High-Level Output Voltage	V_{OHA}	A ports	I_{OH} = -20μA, V_{IB} ≥ V_{CCB} - 0.4V		V_{CCA} × 0.7			V
	V_{OHB}	B ports	I_{OH} = -20μA, V_{IA} ≥ V_{CCA} - 0.4V		V_{CCB} × 0.7			
Low-Level Output Voltage	V_{OLA}	A ports	I_{OL} = 1mA, V_{IB} ≤ 0.15V				0.4	V
	V_{OLB}	B ports	I_{OL} = 1mA, V_{IA} ≤ 0.15V				0.4	
Input Leakage Current	I_I	OE	T_A = +25℃				±1	μA
			T_A = -40℃ to +85℃				±1.5	
Power-Off Leakage Current	I_{OFF}	A ports	V_{CCA} = 0V, V_{CCB} = 0V to 5.5V	T_A = +25℃			±0.5	μA
				T_A = -40℃ to +85℃			±1	
		B ports	V_{CCA} = 0V to 5.5V, V_{CCB} = 0V	T_A = +25℃			±0.5	
				T_A = -40℃ to +85℃			±1	
3-State Output Leakage	I_{OZ}	A or B ports	T_A = +25℃				±0.6	μA
			T_A = -40℃ to +85℃				±1	
Quiescent Supply Current	I_{CCA}	A ports	V_I = V_O = OPEN, I_O = 0A	V_{CCA} = 1.65V to V_{CCB}, V_{CCB} = 2.3V to 5.5V			5.5	μA
				V_{CCA} = 5.5V, V_{CCB} = 0V			5.5	
				V_{CCA} = 0V, V_{CCB} = 5.5V			-1	
	I_{CCB}	B ports	V_I = V_O = OPEN, I_O = 0A	V_{CCA} = 1.65V to V_{CCB}, V_{CCB} = 2.3V to 5.5V			15	μA
				V_{CCA} = 5.5V, V_{CCB} = 0V			-1	
				V_{CCA} = 0V, V_{CCB} = 5.5V			6	
	I_{CCA} + I_{CCB}	A and B ports	V_I = V_O = OPEN, I_O = 0A	V_{CCA} = 1.65V to V_{CCB}, V_{CCB} = 2.3V to 5.5V			20	μA
	I_{CCZA}	A ports	V_I = V_{CCI} or 0V, I_O = 0A, OE = GND	V_{CCA} = 1.65V to V_{CCB}, V_{CCB} = 2.3V to 5.5V			5.5	μA
	I_{CCZB}	B ports	V_I = V_{CCI} or 0V, I_O = 0A, OE = GND	V_{CCA} = 1.65V to V_{CCB}, V_{CCB} = 2.3V to 5.5V			5.5	μA
OE Input Capacitance	C_I	OE	V_{CCA} = 3.3V, V_{CCB} = 3.3V			4		pF
Input/Output Capacitance	C_{IO}	A ports	V_{CCA} = 3.3V, V_{CCB} = 3.3V			5		pF
		B ports				5		

NOTES:

1. V_{CCI} is the supply voltage associated with the data input ports.

2. V_{CCO} is the supply voltage associated with the data output ports.

3. Ensure that V_{CCA} ≤ V_{CCB} and V_{CCA} must not exceed 5.5V.

TIMING REQUIREMENTS

(T_A = +25℃, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	V_{CCB} = 2.5V	V_{CCB} = 3.3V	V_{CCB} = 5V	UNITS
			TYP	TYP	TYP	
(V_{CCA} = 1.8V)						
Data Rate		Push-pull driving	21	22	24	Mbps
		Open-drain driving	2	2	2	
Pulse Duration (Data Inputs)	t_W	Push-pull driving	47	45	41	ns
		Open-drain driving	500	500	500	
(V_{CCA} = 2.5V)						
Data Rate		Push-pull driving	20	22	24	Mbps
		Open-drain driving	2	2	2	
Pulse Duration (Data Inputs)	t_W	Push-pull driving	50	45	41	ns
		Open-drain driving	500	500	500	
(V_{CCA} = 3.3V)						
Data Rate		Push-pull driving		23	24	Mbps
		Open-drain driving		2	2	
Pulse Duration (Data Inputs)	t_W	Push-pull driving		43	41	ns
		Open-drain driving		500	500	
(V_{CCA} = 5V)						
Data Rate		Push-pull driving			24	Mbps
		Open-drain driving			2	
Pulse Duration (Data Inputs)	t_W	Push-pull driving			41	ns
		Open-drain driving			500	

SWITCHING CHARACTERISTICS

(V_{CCA} = 1.8V, T_A = +25℃, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS		V_{CCB} = 2.5V	V_{CCB} = 3.3V	V_{CCB} = 5V	UNITS
				TYP	TYP	TYP	
Propagation Delay	t_{PHL}	From An to Bn	Push-pull driving	2.4	3	4.3	ns
			Open-drain driving	26	26.3	26.7	
	t_{PLH}		Push-pull driving	4	4	4	
			Open-drain driving	175	145	110	
	t_{PHL}	From Bn to An	Push-pull driving	2	2.2	2.3	ns
			Open-drain driving	26	26.1	26.2	
	t_{PLH}		Push-pull driving	1.7	1.5	1.4	
			Open-drain driving	133	69	51	
Enable Time	t_{EN} (t_{PZH} & t_{PZL})	From OE to An or Bn		24	20	18	ns
Disable Time	t_{DIS} (t_{PHZ} & t_{PLZ})	From OE to An or Bn		1200	1200	1200	ns
Rise Time	t_{RA}	A ports	Push-pull driving	7	5.8	5.4	ns
			Open-drain driving	89	31	10	
	t_{RB}	B ports	Push-pull driving	6.5	5.3	4.5	ns
			Open-drain driving	128	98	58	
Fall Time	t_{FA}	A ports	Push-pull driving	2.9	2.7	2.6	ns
			Open-drain driving	1.9	1.7	1.6	
	t_{FB}	B ports	Push-pull driving	4.6	5.9	8	ns
			Open-drain driving	2.2	2.3	2.9	
Channel-to-Channel Skew	t_{SKO}			0.5	0.5	0.5	ns
Data Rate		Push-pull driving		21	22	24	Mbps
		Open-drain driving		2	2	2	

SWITCHING CHARACTERISTICS (continued)

(V_{CCA} = 2.5V, T_A = +25℃, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS		V_{CCB} = 2.5V	V_{CCB} = 3.3V	V_{CCB} = 5V	UNITS
				TYP	TYP	TYP	
Propagation Delay	t_{PHL}	From An to Bn	Push-pull driving	2.7	3.3	4.8	ns
			Open-drain driving	26.2	26.4	26.7	
	t_{PLH}		Push-pull driving	2.6	2.6	2.6	
			Open-drain driving	169	144	110	
	t_{PHL}	From Bn to An	Push-pull driving	2.3	2.3	2.6	ns
			Open-drain driving	26.3	26.4	26.5	
	t_{PLH}		Push-pull driving	2	1.9	1.8	
			Open-drain driving	165	118	55	
Enable Time	t_{EN} (t_{PZH} & t_{PZL})	From OE to An or Bn		23	19	16	ns
Disable Time	t_{DIS} (t_{PHZ} & t_{PLZ})	From OE to An or Bn		1200	1200	1200	ns
Rise Time	t_{RA}	A ports	Push-pull driving	3.4	3	2.8	ns
			Open-drain driving	120	70	10	
	t_{RB}	B ports	Push-pull driving	5.3	3.8	3.1	ns
			Open-drain driving	122	96	62	
Fall Time	t_{FA}	A ports	Push-pull driving	4.9	5	5.5	ns
			Open-drain driving	2	1.9	1.7	
	t_{FB}	B ports	Push-pull driving	4.8	6.1	8.3	ns
			Open-drain driving	1.9	2.1	2.7	
Channel-to-Channel Skew	t_{SKO}			0.5	0.5	0.5	ns
Data Rate		Push-pull driving		20	22	24	Mbps
		Open-drain driving		2	2	2	

SWITCHING CHARACTERISTICS (continued)

(V_{CCA} = 3.3V, T_A = +25℃, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS		V_{CCB} = 3.3V	V_{CCB} = 5V	UNITS
				TYP	TYP	
Propagation Delay	t_{PHL}	From An to Bn	Push-pull driving	3.5	4.9	ns
			Open-drain driving	26.3	26.7	
	t_{PLH}		Push-pull driving	2.2	2.1	
			Open-drain driving	133	104	
	t_{PHL}	From Bn to An	Push-pull driving	3	3.2	ns
			Open-drain driving	26.6	26.8	
	t_{PLH}		Push-pull driving	1.8	1.7	
			Open-drain driving	132	83	
Enable Time	t_{EN} (t_{PZH} & t_{PZL})	From OE to An or Bn		18	15	ns
Disable Time	t_{DIS} (t_{PHZ} & t_{PLZ})	From OE to An or Bn		1200	1200	ns
Rise Time	t_{RA}	A ports	Push-pull driving	2.5	2.4	ns
			Open-drain driving	87	36	
	t_{RB}	B ports	Push-pull driving	3	2.6	ns
			Open-drain driving	87	56	
Fall Time	t_{FA}	A ports	Push-pull driving	6.2	5.8	ns
			Open-drain driving	2.3	2	
	t_{FB}	B ports	Push-pull driving	6.5	8.2	ns
			Open-drain driving	2	2.5	
Channel-to-Channel Skew	t_{SKO}			0.5	0.5	ns
Data Rate		Push-pull driving		23	24	Mbps
		Open-drain driving		2	2	

SWITCHING CHARACTERISTICS (continued)

(V_{CCA} = 5V, T_A = +25℃, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS		V_{CCB} = 5V	UNITS
				TYP	
Propagation Delay	t_{PHL}	From An to Bn	Push-pull driving	6	ns
			Open-drain driving	26.7	
	t_{PLH}		Push-pull driving	1.9	
			Open-drain driving	120	
	t_{PHL}	From Bn to An	Push-pull driving	5.6	ns
			Open-drain driving	27.3	
	t_{PLH}		Push-pull driving	1.7	
			Open-drain driving	126	
Enable Time	t_{EN} (t_{PZH} & t_{PZL})	From OE to An or Bn		16	ns
Disable Time	t_{DIS} (t_{PHZ} & t_{PLZ})	From OE to An or Bn		1200	ns
Rise Time	t_{RA}	A ports	Push-pull driving	2	ns
			Open-drain driving	79	
	t_{RB}	B ports	Push-pull driving	2.3	ns
			Open-drain driving	73	
Fall Time	t_{FA}	A ports	Push-pull driving	8.7	ns
			Open-drain driving	2.7	
	t_{FB}	B ports	Push-pull driving	8.6	ns
			Open-drain driving	2.4	
Channel-to-Channel Skew	t_{SKO}			0.5	ns
Data Rate		Push-pull driving		24	Mbps
		Open-drain driving		2	

WAVEFORMS

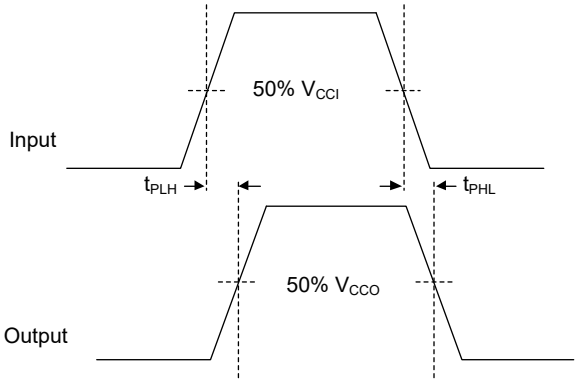


Figure 2. Propagation Delay

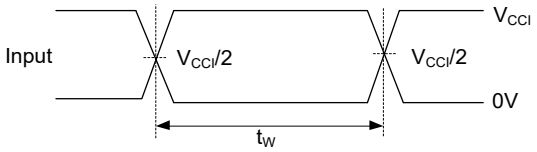


Figure 3. Pulse Duration

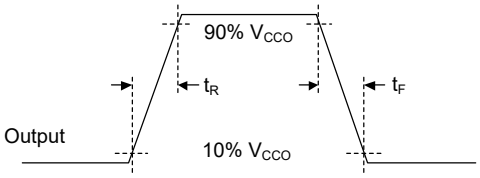
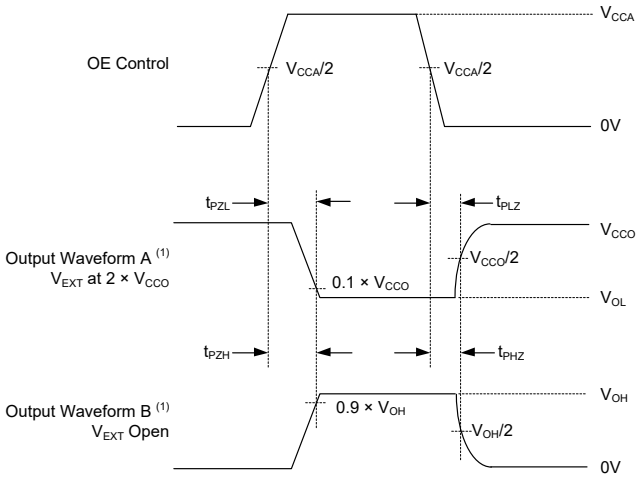


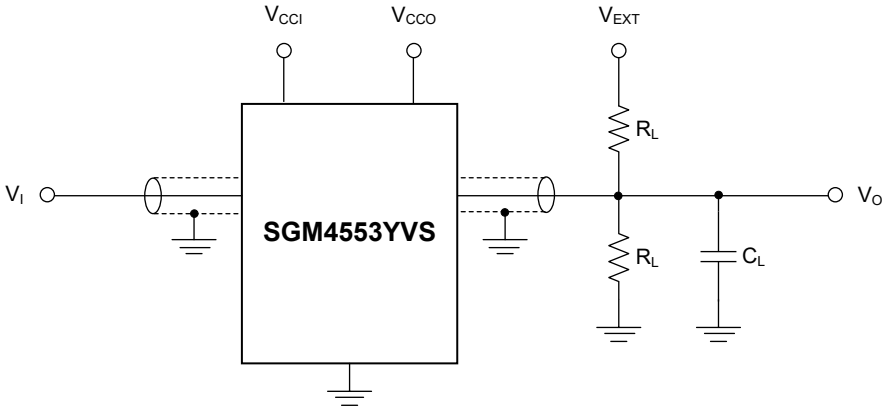
Figure 4. Rise Time and Fall Time of Data Output



NOTE: 1. Waveform A indicates an output that is high except for OE is high. Waveform B indicates an output that is low except for OE is high.

Figure 5. Enable and Disable Times

TEST CIRCUIT



Definitions for test circuit:

R_L = Load resistance.

C_L = Load capacitance includes jig and probe capacitance.

V_{EXT} = External voltage for measuring switching times.

V_{CCI} = Supply voltage associated with the input.

V_{CCO} = Supply voltage associated with the output.

Figure 6. Test Circuit for Measuring Switching Times

APPLICATION INFORMATION

Applications

The SGM4553YVS is a bridge between two digital systems with different power supplies as it can transmit the signal transparently. For the application of the SGM4553YVS, the output driver is open-drain or push-pull to drive the I^2C or one-wire bus. In addition, if a device with push-pull driver is connected to the I/O pin of the SGM4553YVS, it will operate as normal.

Architecture

The SGM4553YVS can switch the direction of the transmission for A port and B port automatically without any external control.

It is not necessary to add an external direction control for the application of the SGM4553YVS. Also, each I/O pin can be an input or output of the voltage translator.

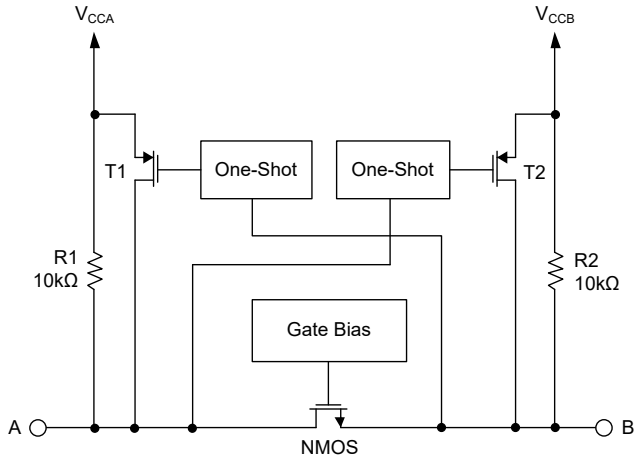


Figure 7. Architecture of an SGM4553YVS Cell

The explanation of two main parts of the internal circuit for the SGM4553YVS is shown as below:

- There is an NMOS between A port and B port to switch on or off the transmission.
- The one-shot accelerator can be used to accelerate the rising edges of the signal for A port and B port automatically.

Input Driver Requirements

The falling time of A port and B port and t_{PHL} depend on the output impedance of the connected device. The values of parameters which are t_{FA}, t_{FB}, t_{PHL} and data rates are specified when the resistance of external driver is less than 50Ω.

Power-Up

For the application of the SGM4553YVS, the V_{CCA} should be less than V_{CCB}. However, it does not matter if the power supply voltage is ramping, and the sequence of power-up for both V_{CCA} and V_{CCB} is not defined.

Output Load Considerations

To decrease the extend of capacitive loading and ensure the proper triggering of one-shot, the trace in PCB should be as short as possible. Also, to ensure that the round-trip reflection delay is smaller than the time period of one-shot, the users should also decrease the length of trace, which means that the signal integrity is guaranteed because of the low impedance for the reflection. The period of on-state for the one-shot part is 30ns. In addition, for the one-shot circuit, it can support lumped capacitive load. In addition, the one-shot circuit has the time-out function, which aims to handle the extremely heavy capacitive load. For the function of one-shot part of the SGM4553YVS, it can optimize the trade-off between the capability of load driving, maximum bit-rate and dynamic supply current. The length of PCB trace and output connectors will be considered as the capacitive load of the device, which may result in the retriggering of one-shot, contention of bus and the oscillations of the output.

Enable and Disable

The function of OE is used to disable SGM4553YVS by setting the transmitting I/O pins to high-impedance mode. The pull-down current source is integrated inside OE once it is powered by V_{CCA}. The definition of disable time (t_{DIS}) is the time period between OE goes low and when all of the I/O pins are in high-impedance mode. The enable time (t_{EN}) is defined as the time period between OE going to high position and one-shot part starting to operate.

Pull-Up or Pull-Down Resistors on I/O Lines

For the I/O pin of A and B side, there is a 10kΩ pull-up resistor to provide a high position for each I/O pin. However, if a smaller pull-up resistor is required, the users can add an external resistor which is parallel with the 10kΩ resistor. Also, the value of V_{OL} can be affected by the added external resistor. In addition, if the user wants to disable the device, the OE pin can be simply set to low position.

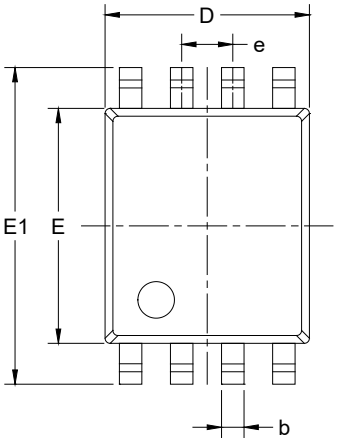
REVISION HISTORY

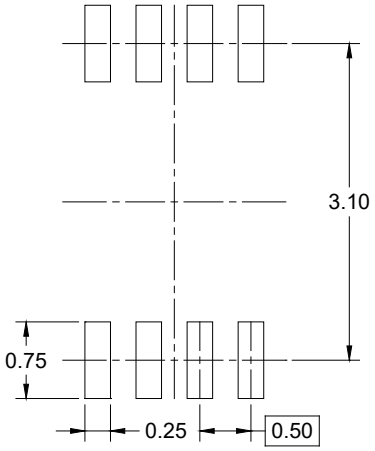
NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from Original to REV.A (NOVEMBER 2025)	Page
Changed from product preview to production data	All

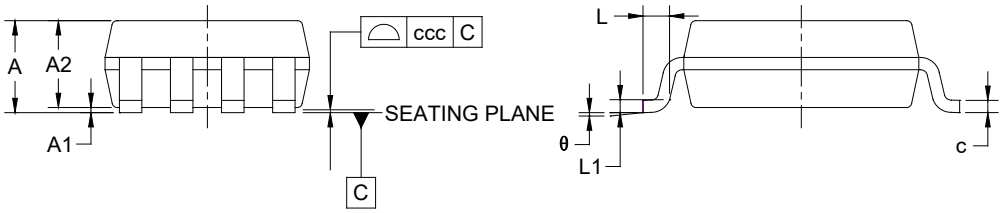
PACKAGE OUTLINE DIMENSIONS

VSSOP-8





RECOMMENDED LAND PATTERN (Unit: mm)

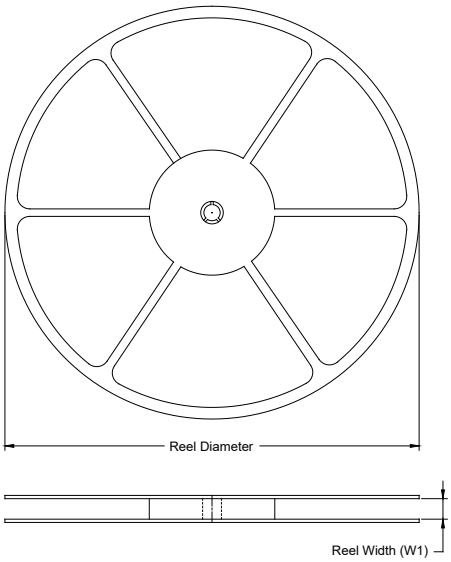


Symbol	Dimensions In Millimeters		
	MIN	NOM	MAX
A	-	-	1.000
A1	0.000	-	0.150
A2	0.600		0.850
b	0.170	-	0.270
c	0.080		0.230
D	1.900	-	2.100
E	2.200	-	2.400
E1	3.000	-	3.200
e	0.500 BSC		
L	0.150	-	0.400
L1	0.120 BSC		
θ	0°	-	8°
ccc	0.100		

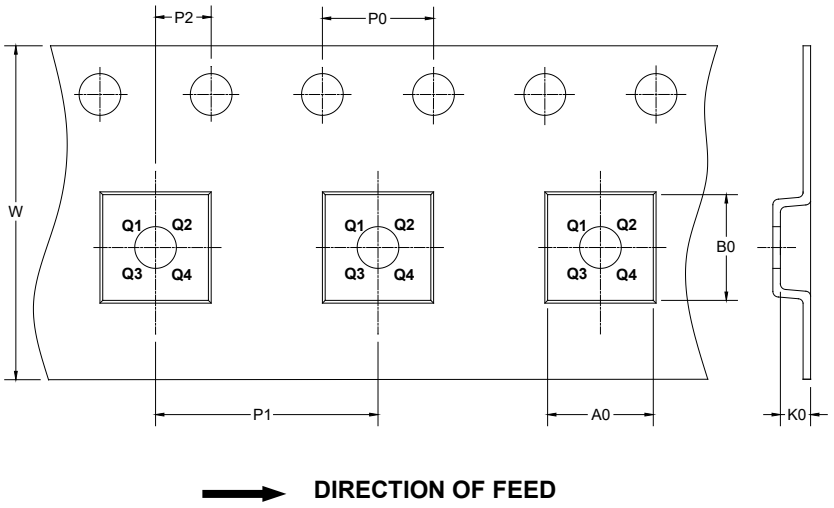
NOTES:
1. This drawing is subject to change without notice.
2. The dimensions do not include mold flashes, protrusions or gate burrs.
3. Reference JEDEC MO-187 CA.

TAPE AND REEL INFORMATION

REEL DIMENSIONS



TAPE DIMENSIONS



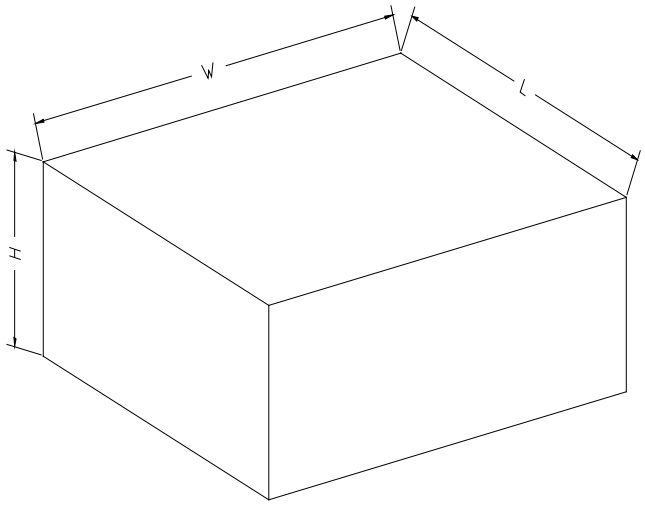
NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
VSSOP-8	7″	9.5	2.25	3.35	1.05	4.0	4.0	2.0	8.0	Q3

DD0001

CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton
7″ (Option)	368	227	224	8
7″	442	410	224	18

DD0002